



TECHNICAL CHARACTERISTICS

1.General Characteristics

Dimensions:55.50L x40.0W x5.80H mm
 Weight:Approx11.2±0.5g
 Contact principle:Landing technology
 Operating positions:shaft up/down/horizontal
 Mounting System:DIP type
 Durability:300,000 cycles min.

3.Electrical Characteristics

Number of contacts (Optional):8 pins
 contact resistance:50mΩtypical,100mΩmax
 insulation resistance:>1000MΩ/500V DC
 Switch type:Blade
 Operation:Normally open

4.Solderability

Wave:260°C,5Sec.Max.
 Vaporphase:Not applicable
 IR reflow: Not applicable
 Manual soldering :360°C,3sec.Max

5.Environmental Characteristics

Operating temperature:−40°C~+85°C
 Operating humidity :10%~+95%RH
 Storage temperature:−40°C~+85°C
 Storage Humidity:10%~95%RH
 thermal Shock:−40°C~+85°C,5cycles
 Damp Heat:40°C,90%RH,10days.
 Salt—Mist:35°C,5%NaCl,24HR

Wellco T&C Co., Ltd.

Smart Card Acceptor

Model No: -C832(DIP)

Normally open (Landing)

REVISION:1.0

DATE: Apr .10.2005